

NEW

Fast Bonding Kit



The practical Adhesive Kit for the professional and fast bonding of all kind of wooden joints and assemblies such as:

- MDF (middle density fibreboard)
- HDF (high density fibreboard)
- Balsa Wood
- Chip Board (worktops)
- Pressboard
- Solid Wood
- Plywood

Also suitable for porous and absorbing metal, rubber und plastic surfaces.

Easy handling:

- Prepare surface to be clean, dry, and free of dust and grease.
- Apply adhesive on one side partially or completely according to the size of the bonding area.
- Cover the other side of the bonding area totally with Activator Spray.
- Position the parts with light pressure and fix them for about 10 seconds. Adhesive which pours out of the bonding gap can be cured by applying additional Activator Spray.
- According to the bonded material and surface, the join can be stressed already within 45–60 seconds.

Additional processing and safety information can be found either on the individual component packing or in the instructions for use enclosed.

Detailed technical information are contained in our WEICON Contact brochure.

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